

LSF-SMD 7.50/04/135 SN BK RL

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image



Similar to illustration

The innovative quick connector - simple, safe and economical:

PCB terminals with spring connection and direct PUSH IN technology. A milestone in connection technology.

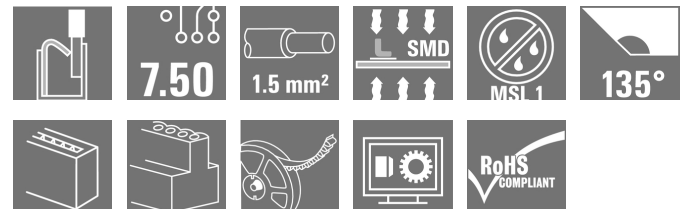
Amazingly simple and simply amazing in practice:

- Connect and easily detach solid wires or wires with wire-end ferrules without using tools
- Processed automatically in the reflow or vapour phase
- Potentials and clamping points marked clearly by coloured push buttons

World-class design-in and processing phases, and suitable for a vast range of applications.

PCB terminal for fully automatic assembly using reflow soldering (SMD), with PUSH IN wire connections. Conductor insertion and slider operation from the same direction (TOP).

- **Solid & flexible conductors with wire-end ferrules need only to be inserted and they are ready.**
- **When connecting stranded wires without wire-end ferrules the actuating element is used to open the terminal point**
- **Intuitive handling – since the wire-entry area and handling area are clearly separated.**
- **Packaged in tape-on-reel**
- **Conductor outlet direction 135°**



General ordering data

Version	Printed circuit board terminals, 7.50 mm, Number of poles: 4, 135°, black, PUSH IN, Clamping range, max.: 1.5 mm², Tape
Order No.	1473910000
Type	LSF-SMD 7.50/04/135 SN BK RL
GTIN (EAN)	4050118280944
Qty.	210 pc(s).
Product data	IEC: 800 V / 12 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 28 - AWG 14
Packaging	Tape

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Technical data

Dimensions and weights

Depth	12.7 mm	Depth (inches)	0.5 inch
Height	14.45 mm	Height (inches)	0.569 inch
Height of lowest version	14.45 mm	Net weight	5.628 g
Width	26.7 mm	Width (inches)	1.051 inch

Temperatures

Continuous operating temp., max.	120 °C
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System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN
Mounting onto the PCB	SMD solder connection	Conductor outlet direction	135°
Pitch in mm (P)	7.5 mm	Pitch in inches (P)	0.295 inch
Number of poles	4	Pin series quantity	1
Fitted by customer	No	Coplanarity:	100 µm
Number of solder pins per pole	2	Stripping length	8 mm
L1 in mm	22.5 mm	L1 in inches	0.885 inch
Touch-safe protection acc. to DIN VDE 0470	IP 20	Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch
Volume resistance	1.60 mΩ		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Layer structure of solder connection	4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, 0.25 mm ² min.	
w. plastic collar ferrule, DIN 46228 pt 4, 0.75 mm ² max.	
w. wire end ferrule, DIN 46228 pt 1, 0.25 mm ² min.	
w. wire end ferrule, DIN 46228 pt 1, 1.5 mm ² max.	

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Clampable conductor	Cross-section for conductor connection	Type	fine-wired
		nominal	0.25 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.25/12 HBL
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.34 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.34/12 TK
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.5 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.5/14 OR
Reference text	Cross-section for conductor connection	Type	fine-wired
		nominal	0.75 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.75/14T HBL
	Cross-section for conductor connection	Type	fine-wired
		nominal	1.5 mm ²
	wire end ferrule	Stripping length	nominal 7 mm
		Recommended wire-end ferrule	H1.5/7
	Length of ferrules is to be chosen depending on the product and the rated voltage. The outside diameter of the plastic collar should not be larger than the pitch (P)		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	12 A
Rated current, max. number of poles (Tu=20°C)	12 A	Rated current, min. number of poles (Tu=40°C)	12 A
Rated current, max. number of poles (Tu=40°C)	12 A	Rated voltage for surge voltage class / pollution degree II/2	800 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	500 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 80 A

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1664286
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

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Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated current (Use group B / UL 1059) 12 A

Wire cross-section, AWG, min. AWG 28

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group D / UL 1059) 10 A

Wire cross-section, AWG, max. AWG 14

Packing

Packaging	Tape	VPE length	40 mm
VPE width	320 mm	VPE height	320 mm
Tape depth (T2)	15.7 mm	Tape width (W)	56 mm
Tape pocket depth (K0)	15.2 mm	Tape pocket height (A0)	11.3 mm
Tape pocket width (B0)	44.06 mm	Tape pocket separation (P1)	20 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	26.2 mm
Tape reel diameter Ø (A)	330 mm	Surface resistance	$R_s = 10^9 - 10^{12} \Omega$

Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ECLASS 9.0	27-44-04-01	ECLASS 9.1	27-44-04-01
ECLASS 10.0	27-44-04-01	ECLASS 11.0	27-46-01-01

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Additional push button colours on request
- Operating force of slider max. 40 N
- Rated current related to rated cross-section & min. No. of poles.
- Wire end ferrule with plastic collar to DIN 46228/4
- Wire end ferrule without plastic collar to DIN 46228/1
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool recommended.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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www.weidmueller.com**Technical data****Approvals**

Approvals



ROHS Conform

UL File Number Search E60693

DownloadsApproval/Certificate/Document of
Conformity[Declaration of the Manufacturer](#)

Engineering Data

[STEP](#)

Engineering Data

[EPLAN, WSCAD](#)

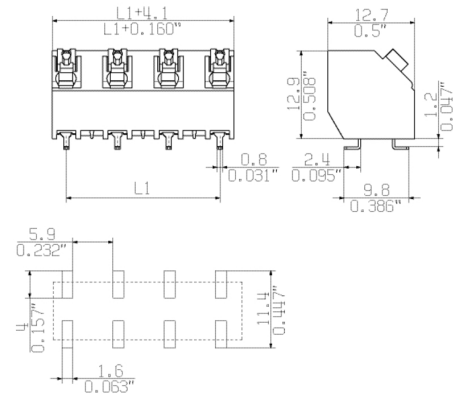
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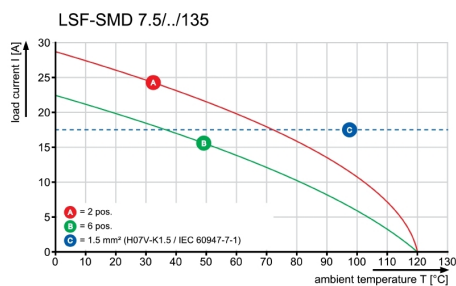
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Drawings

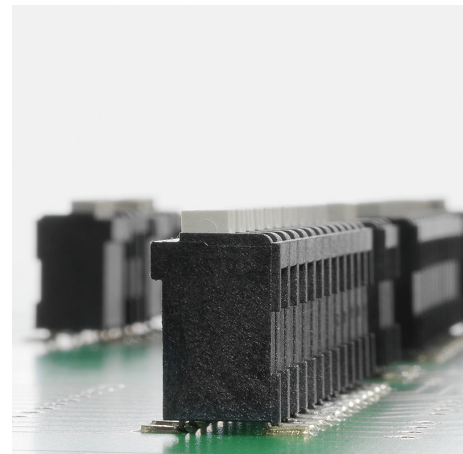
Dimensional drawing



Graph

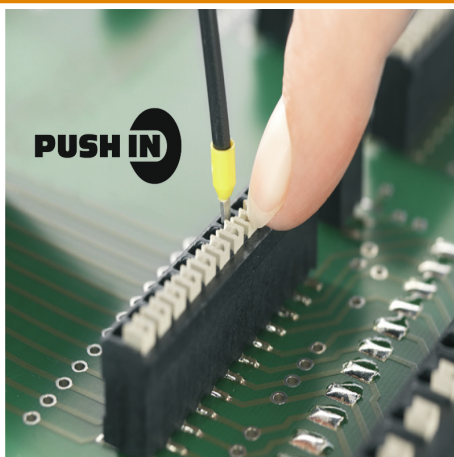


Product benefits



Stable solder connection

Product benefits



PUSH IN wire connection

Product benefits



Packaged in tape-on-reel

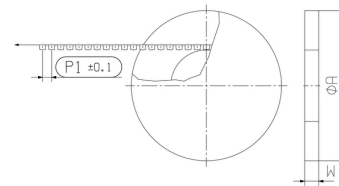
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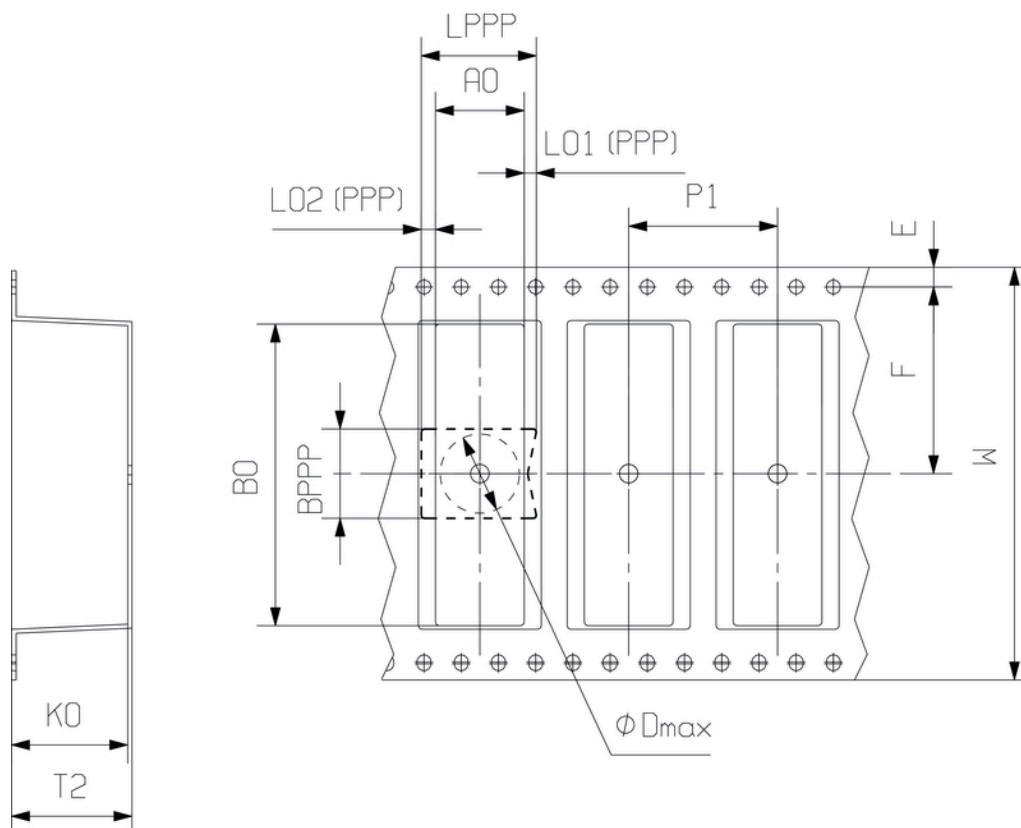
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Drawings

Dimensional drawing

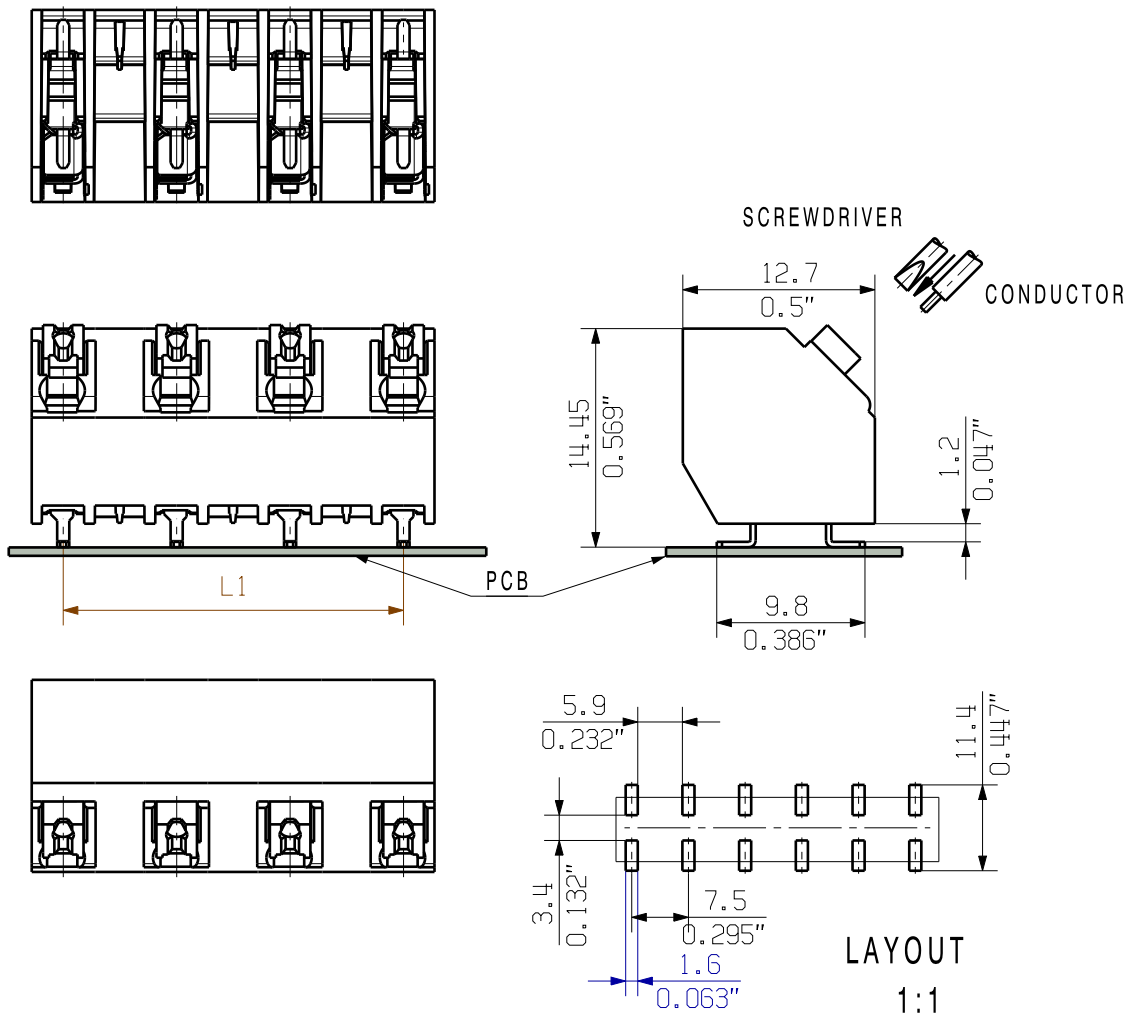


Dimensional drawing



MASSE OHNE TOLERANZ SIND KEINE PRUEFFMASSE
DIMS. WITHOUT TOLERANCE ARE NOT CONTROL DIMS.

DIE DEUTSCHE VERSION IST VERBINDLICH
THE GERMAN VERSION IS BINDING



For the mounting on PCBs, it should be noted that the rated data relates only to the PCB components alone.

The necessary creepage and clearance paths must be observed in the relevant equipment standards in accordance with IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3.

Weidmüller PCB components are rated in accordance with the DIN EN 61984 standard, and are valid for its field of application. If the components are used in accordance with the intended purpose, the components will meet all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress.

SHOWN: LSF-SMD 7.50/04/135...

6	37,5	1,476
5	30,0	1,181
4	22,5	0,886
3	15,0	0,591
2	7,5	0,295
n	L1 [mm]	L1 [Inch]



DIN ISO 2768-m

78009/5
09.09.14 HELIS_MA 00

MODIFICATION



DATE NAME

DRAWN 11.02.2014 HELIS_MA

RESPONSIBLE KRUG_M

CHECKED 30.09.2014 HELIS_MA

APPROVED LANG_T

Weidmüller

CAT.NO.: **C 58004** 00

DRAWING NO. ISSUE NO.
SHEET 01 OF 02 SHEETS

LSF-SMD 7.50/.. /135...
LEITERPLATTENKLEMM
PCB TERMINAL

SCALE: 2:1

SUPERSEDES: .

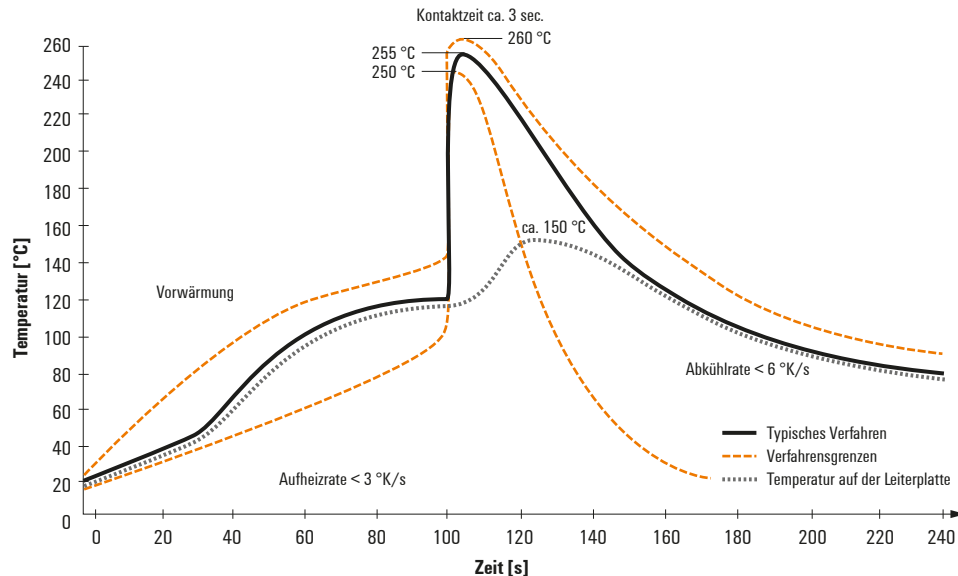
PRODUCT FILE: LSF-SMD 3.50

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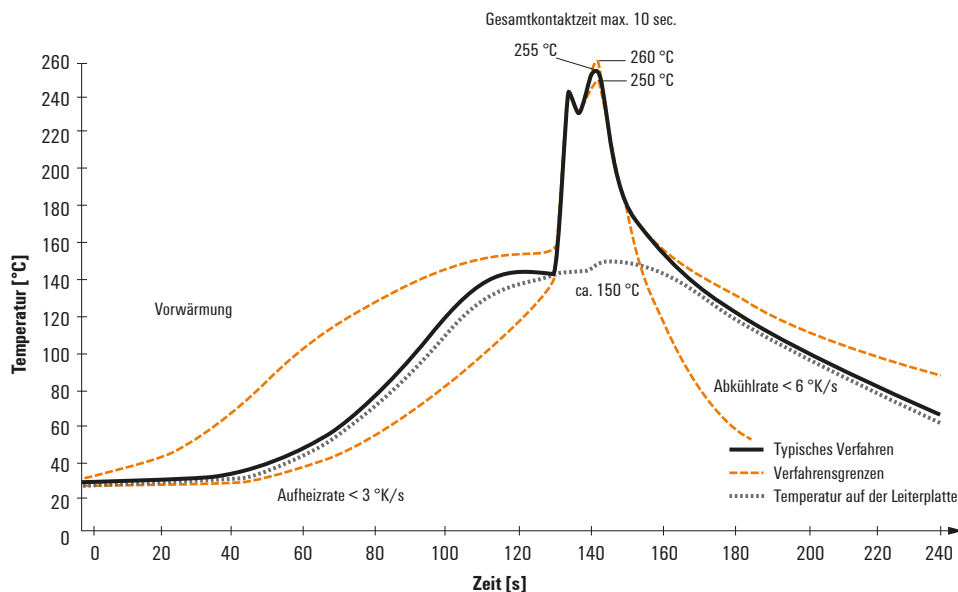
Empfohlene Wellen-Lötprofile

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Einzelwelle:



Doppelwelle:



Wellen-Lötprofile

Bedrahtete Anschlüsselemente sind in Anlehnung an die Norm DIN EN 61760-1 zu verarbeiten. Anbei zwei Empfehlungen für praxisbezogene Wellenlötprofile, mit denen Leiterplattenanschlussklemmen und Steckverbinder von Weidmüller qualifiziert sind.

Bei der Wahl eines passenden Profils für Ihre Anwendung sind unter anderem folgende Faktoren zu beachten:

- Stärke der Leiterplatte
- Cu-Anteile in den Lagen
- Ein-/Beidseitige Bestückung
- Produktspektrum
- Aufheiz- und Abkühlrate

Die Einzel- und Doppelwelle zeigt jeweils den empfohlenen Verarbeitungsbereich inkl. der maximalen Löttemperatur von 260 °C. In der Praxis liegt die maximale Löttemperatur sehr häufig weit unter dem o.g. Maximalprofil.

Recommended reflow soldering profile

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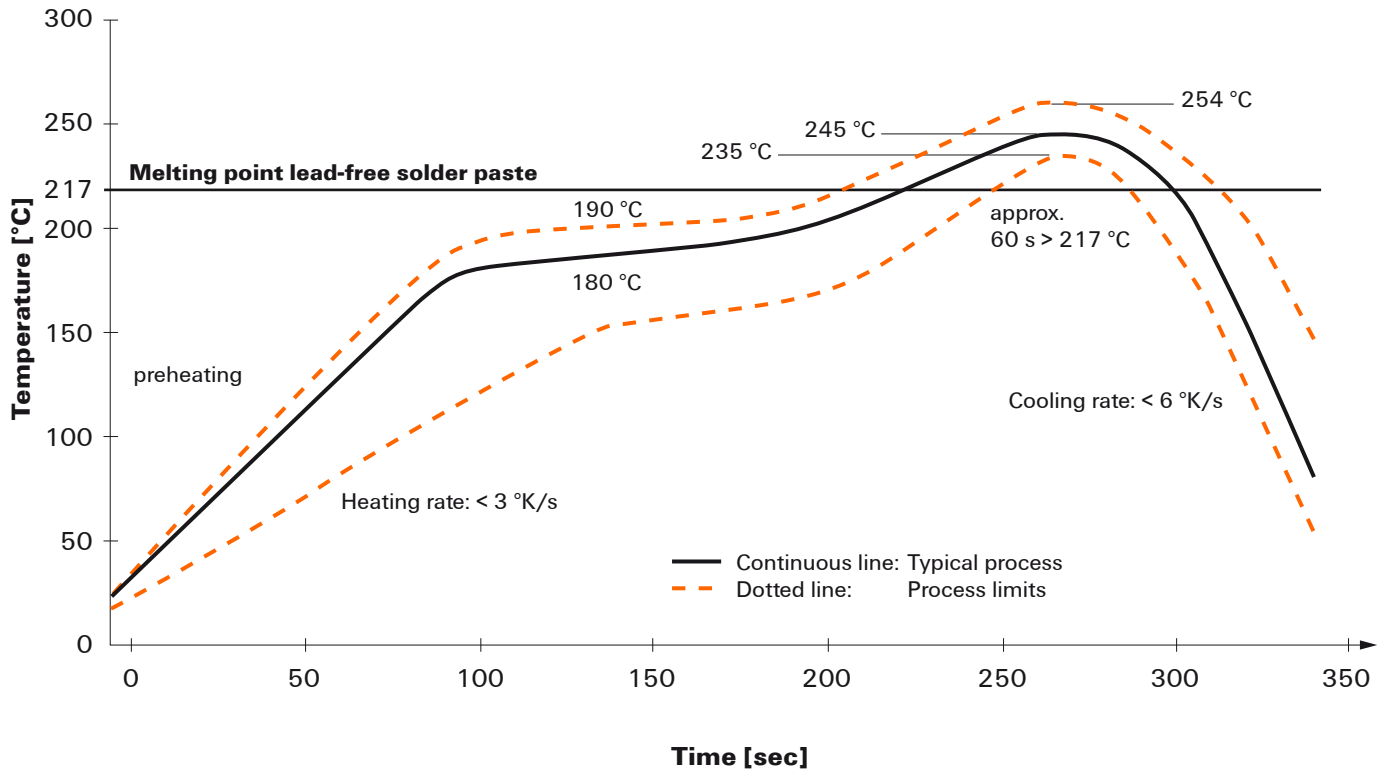
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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.